Camtek Condor 202M Inspection Tool

Manufacturer: Camtek

Model: Condor 202M

Specification:

Specification:		04
Item #		Qty
PR1082800	Condor 202M: Inspection system for pre and post Diced Wafers up to 200 mm 2" manual load and 4"to 8" frame sizes. Include special Chuck accommodating diced wafers with multi size enable. Switch between wafer frame size requires exchange of endeffector and chuck setting. Equipped with 6"-8" cassette for framed wafers and 2 end effectors. Includes ionizer [Ion] and HEPPA filter. * Windows XP operating system * Die edit S/W (online and offline) * SPC (Yield maps, histograms and analysis for die level / wafer level / lot level) * Monochrome inspection camera * Review color camera * Review color camera * Magnifications option: 1x, 1.75x, 2.5x, 5x * Supports unframed wafer sizes 150mm (6") and 200mm (8") * Defect sensitivity of up to 1.8 micron pixel size	1
	* Conforms to CE, SEMI, ISO requirement	
PR2035100	* Auto Loader 200mm (EFEM): Auto loader for 150mm (6") & 200mm (8"). Includes two load ports.Configuration by customer.	1
	Die Editing: employs a user-friendly graphical interface for recipe configuration that allows the user to define even and odd-shaped zones within the die area. Users can set the required different detection criteria areas for each zone. Off-line License available to provide remote operation support installed on separate computers. Automatic Wafer Loader: system accommodates 200mm (8") and 300mm (12") standard wafer cassettes and includes a Robot Arm and Wafer endeffector for 8" and 12" frame [customer selction one frame type standard]. Will support up to 2 cassettes.	

	Color Defect Verification: accommodates 6.3x or 10x magnification verification lenses for defect review in color on screen. Lens magnification to be specified by customer at time of purchase. SPC (Statistic Process Control): generates comprehensive charts to assist the quality engineer in reducing manufacturing process variations, identifying root causes, and enhancing overall production yields. Fan Filter Unit (FFU): Enables class 100 mini environment	
Item #	Optics	
PR2034204	10x Magnification Lense: Set of Objective lens x 10 and S/W for 0.9 microns pixels size. Approve application compliance and delivery time prior to order	1
PR2036400	Color camera and objective x 6.3: Built-in verification camera with 0.9 micron resolution	1
Item #	Software Packages	
PR2033800	Surface Inspection: Algorithms that find surface defects on predefined scan area.	1
PR2035400	Probe Mark Inspection: Algorithm reporting any kind of probe mark defect such as number of touch downs, area, proximity and breakouts from pad edges	1
PR2038900	Multi Recipe: Powerful inspection capability to scan any wafer with different focus and lighting condition. All scan results will be merged into one wafer map.	1
Item #	Wafer Maps	
PR2035900	One Existing Wafer Map Format: AOI will import and update / create reports based on existing format. Formats available: STDF, Semi G85, TSK, TEL, EG_SORTNET, SINF, ESC, ITSK, TI_WWWM, STIF, SINF, KLA, etc.	1
	OCR Barcode	
PR2062100	Top Optical Character Recognizer: Automatically reads the Wafer ID from the Top. Applicable for 200 mm systems	1
PR2050800	Double barcode reader for framed wafers - Automatically reads the barcode of a framed wafer. Enables reading any 2 barcode positions on the frame	1